

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT5442143

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHI-WEN LIN	03/21/2019
TSUNG-CHING LIN	03/21/2019
WEI-CHI LIU	03/21/2019
RECEIVING PARTY DATA	
Name:	CORETRONIC CORPORATION
Street Address:	NO. 11, LI-HSIN RD., HSINCHU SCIENCE PARK,
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16361229
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	78648-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	03/27/2019
Total Attachments: 2	
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ASSIGNMENT

WHEREAS,

1. Shi-Wen Lin
2. Tsung-Ching Lin
3. Wei-Chi Liu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title:

LIQUID-COOLING DEVICE

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS 1. Coretronic Corporation
of No. 11, Li-Hsin Rd., Hsinchu Science Park, Hsin-Chu 300, Taiwan,
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have assigned and transferred, and by these presents does/do assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Shi-Wen Lin
Sole or First Joint Inventor: Shi-Wen Lin

Date: MAR 21 2019

Signature: Tsung-Ching Lin
Second Joint Inventor (if any): Tsung-Ching Lin

Date: MAR 21 2019

Signature: Wei-Chi Liu
Third Joint Inventor (if any): Wei-Chi Liu

Date: MAR 21 2019